

PATENT APPLICATIO

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

in re Application of: MASATAKA ITO	Examiner: Not Yet Assigned Group Art Unit: 2812	
Application No.: 10/091,461 Filed: March 7, 2002 For: SOI SUBSTRATE, ANNEALING METHOD THEREFOR, SEMICONDUCTOR DEVICE HAVING THE SOI SUBSTRATE,	HAY 16 2002 HNOLOGY CENTER	RECEIVED
AND METHOD OF MANUFACTURING THE SAME) : May 14, 2002	

Commissioner for Patents Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT

Sir:

In compliance with the duty of disclosure under 37 C.F.R. $\S~1.56$ and in accordance with the practice under 37 C.F.R. §§ 1.97 and 1.98, the Examiner's attention is directed to the documents listed below and on attached Form PTO-1449. Copies of the listed documents are also enclosed.

> U.S. Patent No. 5,869,387 U.S. Patent No. 6,171,982 Japan 05-152230 Japan 05-217821 Japan 11-265893

"Nano-Defects In Commercial Bonded SOI And SIMOX", D.K. Sadana et al., 1994 IEEE International SOI Conference Proceedings, October 1994, pp. 111-112.

"Extremely Low Si Etching (<1nm) During Hydrogen Annealing of Silicon-on-Insulator", N. Sato et al., Extended Abstracts of the 1998 International Conference on Solid State Devices And Materials, Hiroshima, 1998, pp.298-299.

"Suppression of Si Etching During Hydrogen Annealing of Siliconon-Insulator" N. Sato et al., 1998 IEEE International SOI Conference Proceedings, October 1998, pp. 17-18.

"Hydrogen Annealing Treatment Used To Obtain High Quality SOI Surfaces" H. Moriceau et al., 1998 IEEE International SOI Conference Proceedings, October 1998, pp. 37-38.

"Defect Reduction of Bonded SOI Wafers By Post Anneal Process In H₂ Ambient", N. Tate et al., 1998 IEEE International SOI Conference Proceedings, October 1988, pp. 141-142

English-language abstracts for the above-listed Japanese patent documents are enclosed. Further, U.S. Patent No. 5,869,387 is believed to be an English language counterpart to JP 5-217821.

Inasmuch as the subject application has not yet received a first Office

Action, it is believed that this Information Disclosure Statement is timely. See 37 C.F.R. §

1.97(b)(3).

Accordingly, the Examiner is urged to study this information in its entirety and to form an independent determination of the materiality of the information to the claimed invention. Additionally, the Examiner is requested to indicate that this information has been considered by initialing the appropriate portion of Form PTO-1449.

Applicant's undersigned attorney may be reached in our Costa Mesa,

California office by telephone at (714) 540-8700. All correspondence should continue to be directed to our address given below.

Respectfully submitted,

Registration No. 39,000

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	5,869,387	02/09/1999	Sato et al.		43	0 7	795	12/22/1998
	6,171,982	01/09/2001		Sato	43	,		-
			FOREIGN PATENT DOCUMENTS					TRANSLATION YES/NO/
		DATE		COUNTRY	CL	ASS SU	BCLASS	OR ABSTRAC
	DOCUMENT NUMBER			Japan				Abstrac
	05-152230 06/18/199	06/18/1993			\dashv			Abstrac
	05-217821	08/27/1993	Japan 		+	-		Abstrac
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		OTHER DOCUM	ENT(S) (Including	Author, Title, Date, Pertinent Pages, Et	c.)	1 100	M IEE	EIE.
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*EXAMINER: initial if reference considered, whether or not citation is in conformance with MPEP 809; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. Sheet_1_ of _1_

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